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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

: MOMENI et al.

PCT No

: PCT/DE99/02554

Filed

: February 7, 2001

For

: A METHOD....

Dated

: February 23, 2001

Hon. Commissioner of Patents and Trademarks Washington, D.C. 20231

PRELIMINARY AMENDMENT

Prior to initial examination, please amend the above-identified application as follows:

IN THE SPECIFICATION:

Please replace the specification originally filed, with the enclosed substitute specification. A marked up copy of the original specification is attached. Applicant states that no new matter has been added.

IN THE CLAIMS:

Please replace claims 1 to 20 without prejudice with the following new claims for initial examination on the merits:

21. A method for placing a multitude of shaped parts of solder material on a bond pad arrangement of a substrate, said bond pad arrangement comprising a multitude of bond

A, sub